ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	© Co	terial Compo pyright 2005. IPC, Bannoo nternational and Pan-Ameri	kburn, Illinois	. All rights reserv	tion with lower	r level p	arts, the	declaration	n encomp	asses all lo		ials for w	hich the	tem is an assembly manufacturer has		
1752-2 1.1	IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x								Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informa							
Supplier Information																
Company Name * Company Unique				Unique ID Au	ue ID Authority		Response Date *			esponse Do	cument ID					
Anaren Microwave				2018-	04-18											
Contact Name *	Title - Contact		Phone - Cor	Email	- Contac	t *										
Sarvesh Nair		Project Engineer		315-432-890	sarve	sh.nari@	anaren.c	om	Duplicat	te Contact -:	> Authoriz	zed Repr	resentative			
Authorized Representati	Title - Representative	е	Phone - Representative *		Email	Email - Representative *			Supplier Comments or URL for Additional Information							
Sarvesh Nair		Project Engineer		315-432-890	sarvesh.nari@anaren.com											
Requester Item Number		Mfr Item Number		Mfr Item Name)	Effectiv	ve Date	Version	Manufact	uring Site	Weight *	UOM	1	Unit Type		
		1P603AS		Hybrid Coupl	2018-0	04-18	A	East Syr	acuse	0.1059545	7 g	E	Each			
Alternate Recommenda	ite Recommendation							Alternate	Item Com	ments		10				
Manufacturing Proces	ss In	formation		L												
Terminal Plating / Grid Array Material Terminal			Terminal B	ase Alloy	ating	ting Peak Process Body Temp			ıre Max Tim	e at Peak Temp	erature N	umber of	Reflow Cycles			
			CU Alloy	,			2	260 C		30 see						
Comments Compliant to RoHS 2 Dir	ectiv	e 2011/65/EU of the	Europear	Parliament	and of the Coun	cil of 8	June 201	1 & Com	mission	Delegated	Directive 201	5/863/EU	of 31 M	arch 2015.		

Save the fields in Import fields from a Clear all of the Lock the fields on this **Export Data** Import Data Reset Form Lock Supplier Fields this form to a file file into this form fields on this form form to prevent changes **RoHS Material Composition Declaration Declaration Type *** Custom Rohs Directive Rohs Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenvls (PBB). Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium 2002/95/EC Addendum: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Bis(2-ethylhexyl) phthalate (DEHP), Butyl benzyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP). Supplier certifies that it gathered the information it provides in this form concerning RoHS restrictive substances using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. Supplier Acceptance * Accepted 1 - Item(s) does not contain RoHS restricted substances per the definition above **RoHS Declaration *** Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions. **Declaration Signature** Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign

the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem			Homogeneous	Weight	Unit of			Level	Substance Category			Substance	CAS	Evemnt	vveiant	Unit of Measure	Tolerance		PPM
	Name			Material	Weight	Measure			Level				Substance	UA3	Lxempt			-	+	
+1 -1	1P603AS	+M	-M	Tin Plating	0.00011	3 g	+C	-C	Supplier	Tin Plating	+S	Ģ	Tin (Sn)	7440-31-5		0.000113	g			1,000,0
		+M	-M	Copper Plating	0.018749	9 g	+C	-C	Supplier	Copper Plating	+S	Ģ	Copper (Cu)	7440-50-8		0.018749	g			1,000,0
		+M	-M	Copper Cladding	0.01698	3 g	+C	- C	Supplier	Copper Cladding	+S	ှ	Copper (Cu)	7440-50-8		0.016983	g			1,000,0
		+M	-M	Dielectric	0.06525	3 g	+C	- C	Supplier	Dielectric	+S	ှ	Fiberglass	65997-17-3		0.035714	g			547,32
							+C	٠	Supplier	Dielectric	+S	-S	Resin	Proprietary		0.028955	g			443,73
							+C	h	Supplier	Dielectric	+S	-S	Ceramic Filler	Proprietary		0.000583	g			8,936.1
		+M	-M	Prepreg	0.00485	4 g	+C	ڼ.	Supplier	Prepreg	+S	-S	Fiberglass	65997-17-3		0.001359	g		·	280,00
					·		+C	-C	Supplier	Prepreg	+S	-S	Resin	Proprietary		0.003495	g			720,00

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